

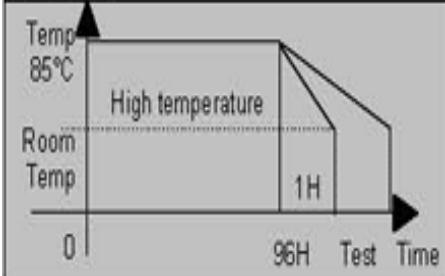
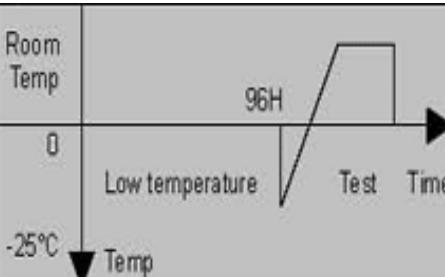
# Shenzhen Highstartech Co.,Ltd

## RELIABILITY AND TEST CONDITIONS

ITEM 项目	PERFORMANCE 标准	TEST CONDITION 测试条件
Flexure strength  弯折强度	The terminal electrode and chip body must not be damaged by the forces applied  端电极在右列测试条件下，不得与产品本体分离	Solder a chip on a test substrate bend the substrate by 2mm(0.079in) and return
Heat resistance (High temperature load)  高温放置测试	Appearance:on damage. Impedance:within ±20% of initial value. Inductance:within ±20% of initial value. Q:within ±30% of initial value  外 观：不能破损 阻抗值：变异性初始值20%以内。 电感值：变异性在初始值15%以内。 Q 值：变异性在初始值30%以内。	Applied current:max rated current Temperature:85±5°C Test time:1008±12hrs Measure at room temperature after Placing for 24hrs   须加电流：最大额定电流 温度： 85±5°C 放置时间： 1008±12hrs 测试结束后于室内放置24hrs,始可测试电气特性
Humidity resistance  高湿放置测试	Appearance:on damage. Impedance:within ±20% of initial value. Inductance:within ±20% of initial value. Q:within ±30% of initial value  外 观：不能破损 阻抗值：变异性初始值20%以内。 电感值：变异性在初始值15%以内。 Q 值：变异性在初始值30%以内。	Humidity:90-95% RH Temperature:40±5°C Applied current:max rated current Test time:1008±12hrs Measure at room temperature after Placing for 24hrs   湿度： 90-95% 温度： 40±5°C 须加电流： 最大额定电流 放置时间： 1008±12hrs 测试结束后于室内放置24hrs,始可测试电气特性
热冲击试验 (温度周期)  低温放置测试	Appearance:on damage. Impedance:within ±20% of initial value. Inductance:within ±20% of initial value. Q:within ±30% of initial value  外 观：不能破损 阻抗值：变异性初始值20%以内。 电感值：变异性在初始值15%以内。 Q 值：变异性在初始值30%以内。	Temperature:-40±5°C to 85±5°C and keep 30 times.Cycle:5cycles Measure at room temperature after Placing for 24hrs   温度： -40±5°C to 85±5°C 须各放置30分钟达5周期 测试结束后于室内放置24hrs,始可测试电气特性
Low temperature storage test  低温放置测试	Appearance:on damage. Impedance:within ±20% of initial value. Inductance:within ±20% of initial value. Q:within ±30% of initial value  外 观：不能破损 阻抗值：变异性初始值20%以内。 电感值：变异性在初始值15%以内。 Q 值：变异性在初始值30%以内。	Temperature:-40±5°C Test time:1008±12hrs Measure at room temperature after Placing for 24hrs   温度： -40±5°C 放置时间： 1008±12hrs 测试结束后于室内放置24hrs,始可测试电气特性

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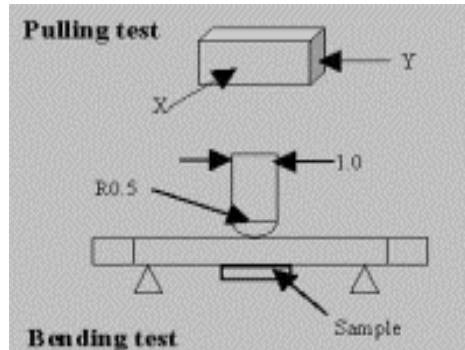
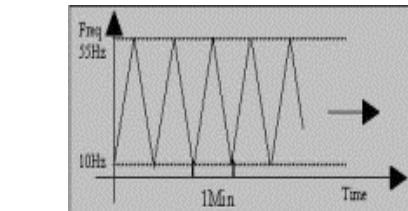
## RELIABILITY TEST CONDITIONS

Item(项目)	Required Characteristics (要求)	Test Method/Condition (測試方法)
High temperature Storage test Reference documents: MIL-STD-202G Method 108A 高溫儲存試驗	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$ 1. 無明顯的外觀缺陷 2. 感值變化不超過10% 3. 品質因數變化不超過30% 4. 直流電阻變化不超過10%	Temperature: $85 \pm 2^\circ\text{C}$ Time : $96 \pm 2$ hours Tested not less than 1 hour, nor more than 2 hours at room temperature. 溫度: $85 \pm 2^\circ\text{C}$ , 時間: $96 \pm 2$ 小時樣品在室溫下放置1小時, 不超2小時必須測試. 
Low temperature Storage test Referenced documents: IEC 68-2-1A 6.1 6.2 低溫儲存試驗	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$ 1. 無明顯的外觀缺陷 2. 感值變化不超過10% 3. 品質因數變化不超過30% 4. 直流電阻變化不超過10%	Temperature: $-40 \pm 3^\circ\text{C}$ Time : $500 \pm 12$ hours Tested not less than 1 hour, nor more than 2 hours at room temperature. 溫度: $-40 \pm 3^\circ\text{C}$ , 時間: $500 \pm 12$ 小時樣品在室溫下放置1小時, 不超2小時必須測試. 
Humidity test Reference documents: MIL-STD-202G Method 103B 濕度測試	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$ 1. 無明顯的外觀缺陷 2. 感值變化不超過10% 3. 品質因數變化不超過30% 4. 直流電阻變化不超過10%	1. Dry oven at a temperature of $40^\circ \pm 5^\circ\text{C}$ for 24 hours. 2. Measurements At the end of this period 3. Exposure: Temperature: $40 \pm 2^\circ\text{C}$ , Humidity: $93 \pm 3\%\text{RH}$ Time : $96 \pm 2$ hours 4. Tested while the specimens are still in the chamber 5. Tested not less than 1 hour, nor more than 2 hours at room temperature. 1. 樣品必須先在 $40^\circ \pm 5^\circ\text{C}$ 條件下乾燥24小時 2. 乾燥後測試 3. 暴露: 溫度: $40 \pm 2^\circ\text{C}$ , 濕度: $93 \pm 3\%\text{RH}$ 時間: $96 \pm 2$ hours 4. 暴露結束後, 在試驗箱中進行測試。 5. 樣品在室溫下放置1小時, 不超2小時必須測試.

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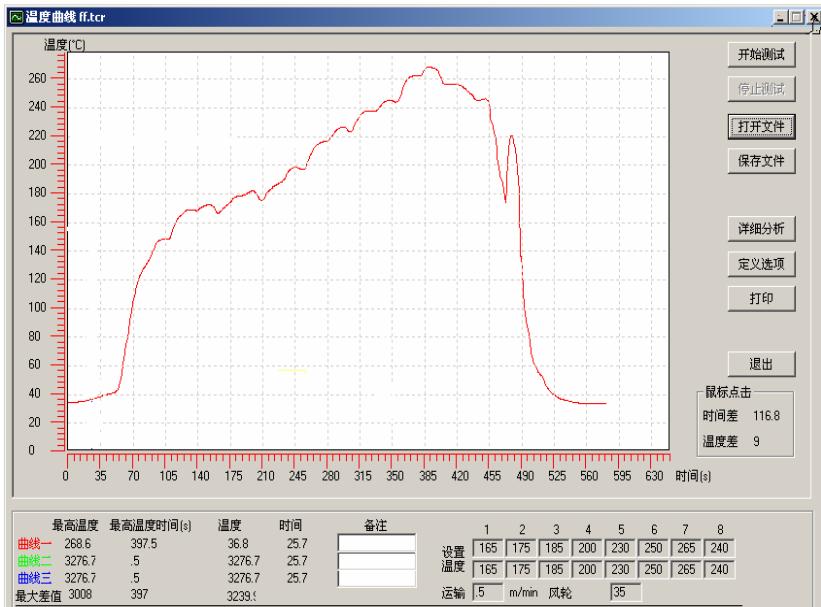
## RELIABILITY TEST CONDITIONS

Item(项目)	Required Characteristics (要求)	Test Method/Condition (測試方法)
Solderability test Reference documents: MIL-STD-202G Method 208H IPC J-STD-002B 可焊性測試	Terminals area must have 95% min. Solder coverage 端子必須有95%以上著錫	Dip pads in flux then dip in solder pot at $245 \pm 5^\circ\text{C}$ for 5 second. Flux: rosin flux 端子浸入助焊劑，然後浸入 $245 \pm 5^\circ\text{C}$ 錫爐中5秒 焊料：Green Products 助焊劑：松香助焊劑
Vibration test Reference documents: MIL-STD-202G Method 201A 振動測試	1.No case deformation or change in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$ 無明顯的外觀缺陷 感值變化不超過10% 品質因數變化不超過30% 直流電阻變化不超過10%	Apply frequency 10~55~10Hz. 1.5mm amplitude in each of perpendicular direction for 2 hours.(total 6 hours) 用10~55~10Hz 振動頻率1.5mm振幅沿X,Y,Z方向各振動2小時.(共4小時)
Drop test Reference documents: MIL-STD-202G Method 203C 落下試驗	1.No case deformation or change in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$ 1.無明顯的外觀缺陷 2.感值變化小於10% 3.品質因數變化小於30% 4.直流電阻變化小於10%	Packaged & Drop down from 1m with $981\text{m/s}^2(100\text{G})$ attitude in 1 angle 1 ridges & 2 surfaces orientations. 將產品包裝後從1米高度自然落下至試驗板上,將按照一角三棱六面的順序執行。一角為包裝底部與包裝的折合處相交的點,三棱為一點相交的三條棱,六面為外包裝的六面,共計10次。
Terminal strength push test Reference documents: JIS C 5321:1997 端子強度試驗	Pulling test: DEFINE: A: sectional area of terminal $A \leq 8 (\text{Sq M})$ force $\geq 5\text{N}$ time:30sec $8(\text{Sq M}) < A \leq 20(\text{Sq M})$ force $\geq 10\text{N}$ time : 10sec $20(\text{Sq M}) < A$ force $\geq 20 \text{ N}$ time: 10sec Bending test: Soldering the products on PCB,after the pulling test and bending test ,terminal should not pull off 定義: A: 焊接端子截面積 $A \leq 8(\text{Sq M})$ 推力 $\geq 5$ 牛頓時間: 30秒 $8(\text{Sq M}) < A \leq 20(\text{Sq M})$ 推力 $\geq 10$ 牛頓 時間: 10秒 彎折測試: 將產品焊於PCB上,分別經過推力測試和彎折測試後,端子不會發生松脫	Bend the testing PCB at middle point, the deflection shall be 2mm 將PCB對中彎折,到達撓度2mm



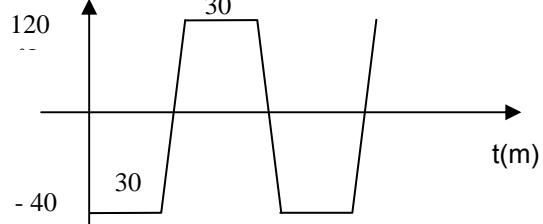
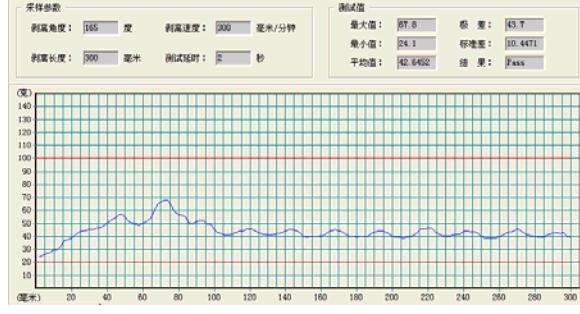
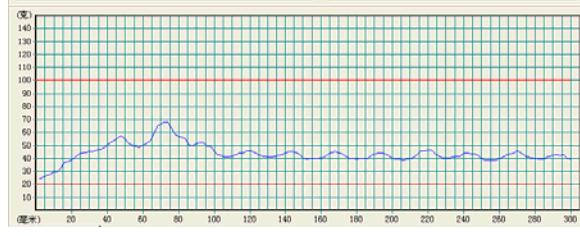
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## RELIABILITY TEST CONDITIONS

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Heat endurance of reflow soldering Reference documents: IPC-J-STD-020B 回流焊测试	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$ 1. 無明顯的外觀缺陷 2. 感值變化小於(小于等于)10% 3. 品質因數變化小於 (小于等于) 30% 4. 直流電阻變化小於 (小于等于) 10%	Refer to the next page reflow curve Go through 3 times The peak temperature : $260 \pm 5^\circ\text{C}$ 參照下图回流焊曲線過三次 峰值溫度為: $260 \pm 5^\circ\text{C}$																																																				
surface temperature of coil	 <table border="1"> <thead> <tr> <th>最高温度</th> <th>最高温度时间(s)</th> <th>温度</th> <th>时间</th> <th>备注</th> </tr> </thead> <tbody> <tr> <td>曲线一 268.6</td> <td>397.5</td> <td>36.8</td> <td>25.7</td> <td></td> </tr> <tr> <td>曲线二 3276.7</td> <td>5</td> <td>3276.7</td> <td>25.7</td> <td></td> </tr> <tr> <td>曲线三 3276.7</td> <td>5</td> <td>3276.7</td> <td>25.7</td> <td></td> </tr> <tr> <td>最大差值</td> <td>3008</td> <td>3008</td> <td>3239.1</td> <td></td> </tr> </tbody> </table> <table border="1"> <thead> <tr> <th>设置</th> <th>1</th> <th>2</th> <th>3</th> <th>4</th> <th>5</th> <th>6</th> <th>7</th> <th>8</th> </tr> </thead> <tbody> <tr> <td>温度</td> <td>165</td> <td>175</td> <td>185</td> <td>200</td> <td>230</td> <td>250</td> <td>265</td> <td>240</td> </tr> <tr> <td>运输</td> <td>5</td> <td>n/min</td> <td>风轮</td> <td>35</td> <td></td> <td></td> <td></td> <td></td> </tr> </tbody> </table>		最高温度	最高温度时间(s)	温度	时间	备注	曲线一 268.6	397.5	36.8	25.7		曲线二 3276.7	5	3276.7	25.7		曲线三 3276.7	5	3276.7	25.7		最大差值	3008	3008	3239.1		设置	1	2	3	4	5	6	7	8	温度	165	175	185	200	230	250	265	240	运输	5	n/min	风轮	35				
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Electonic characteristic test of major products 主要产品电气特性测试。	Refer to catalogue of specific products 参照具体的产品目录页	Refer to catalogue of specific products 参照具体的产品目录页																																																				
Overload test reference documents: JIS C5311-6.13 过负荷试验	1. During the test no smoke,no peculiar smell,no fire 2. the characteristic is normal after test 1. 试验过程中无冒烟,异味,着火等. 2. 试验后产品特性正常.	Apply twice as rated current for 5 minutes. 通过两倍额定电流5分钟.																																																				
Voltage resistance test Referenced documents: MIL-STD-202G Method 301 绝缘耐压测试.	1. During the test no breakdown. 2. the characteristic(characteristics) is normal after test. 1. 试验过程中无击穿. 2. 试验后产品特性正常.	For parts with two coils DC1000V, current: 1mA, time: 1Min. 只针对SMT二绕组以上电压DC1000V, 电流1mA, 时间1分钟.																																																				

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## RELIABILITY TEST CONDITIONS

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warm and cool impact test 冷热冲击试验	<p>1.No case deformation or change in appearance.      2.<math>\Delta L/L \leq 10\%</math>      3.<math>\Delta Q/Q \leq 30\%</math>      4.<math>\Delta DCR/DCR \leq 10\%</math></p> <p>1.無明顯的外觀缺陷      2.感值變化小於10%      3.品質因數變化小於30%      4.直流電阻變化小於10%</p>	<p>change the temperature from 120 °C to -20 °C . It is five minutes .it is 30 minutes of high temperature . it is 30minutes of low temperature . one hour is a circle . it is total 20circles .</p> <p>溫度120°C与-20°C转换,转换时间5M.高温30分钟,低温30分钟.一个小时一个循环, 20个循环。</p> 																																																	
test the steam if it is ageing 蒸气老化试验	<p>1.No case deformation or change in appearance.      2.<math>\Delta L/L \leq 10\%</math>      3.<math>\Delta Q/Q \leq 30\%</math>      4.<math>\Delta DCR/DCR \leq 10\%</math></p> <p>1.無明顯的外觀缺陷      2.感值變化小於10%      3.品質因數變化小於30%      4.直流電阻變化小於10%</p>	80°C, 95RH, 4 小时。4 hours																																																	
test viscous force of carrier by the picture on the right 推拉力测试载带粘力测试 (要求如图)	拉力范围在20~100g范围. pull (20—100g )	 																																																	
ROHS harmful material test	附合ROHS要求,客户有要求时按客户要求执行: 1. Pb≤1000ppm 2. Cd≤100ppm 3. Hg≤1000ppm 4. Cr+6≤1000ppm 5. PBB≤1000ppm 6. PBDE≤1000ppm	<p>按IEC62321方法中化学方法测试。 (Use chemical methods of IEC62321)</p> <table border="1"> <thead> <tr> <th>项目</th> <th>铅</th> <th>镉</th> <th>汞</th> <th>六价铬</th> <th>PBBs</th> <th>PBDEs</th> </tr> </thead> <tbody> <tr> <td>玻璃&amp;陶瓷</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td></td> <td></td> </tr> <tr> <td>金属</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td></td> <td></td> </tr> <tr> <td>墨水&amp;颜料 &amp;染料</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td></td> <td></td> </tr> <tr> <td>塑胶</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> </tr> <tr> <td>包材</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> </tr> <tr> <td>其它材料</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> <td>/</td> </tr> </tbody> </table>	项目	铅	镉	汞	六价铬	PBBs	PBDEs	玻璃&陶瓷	/	/	/	/			金属	/	/	/	/			墨水&颜料 &染料	/	/	/	/			塑胶	/	/	/	/	/	/	包材	/	/	/	/	/	/	其它材料	/	/	/	/	/	/
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